Connectors

MIL-PP push-pull connectors



The new standard in push-pull connectors

- Ultra-lightweight
- Ultra high-pitch contact density, up to 30 ways
- Fully environmentally sealed to 20m in both mated & unmated conditions
- High-speed data capability, inc USB and Ethernet
- Robust design for the most demanding environments
- Positive, blind mateable, key-keyway engagement system
- Fully scoop-proof, to prevent accidental contact damage
- RoHS, Reach & WEEE compliant
- Low-lustre, non-reflective, black finish



Specifications:

Materials

- Shells: Aluminium Alloy (Aerospace grade)
- Insulators: Rigid Polymer
- Contacts: Copper alloy

Standard Plating Finishes

- Metal parts: Non-reflective black finish (ROHS compliant).
- Contacts: Gold

Mechanical Features

- Coupling: push pull, blind mating.
- Keying: 5 orientations available
- Contact type: Solder and PCB pins
- Contact Retention: Assembled and injection moulded in position.
- Endurance: 5000 operations minimum

Environmental Ratings

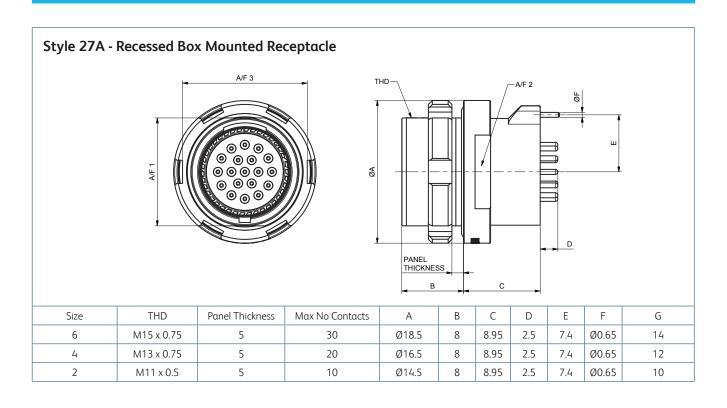
- Temperature Range: -55 to +125°C
- Vibration: 16hrs random
- Sealing: IP68 2 bar (20 metres) mated and un-mated
- Salt Spray: 1000 Hours

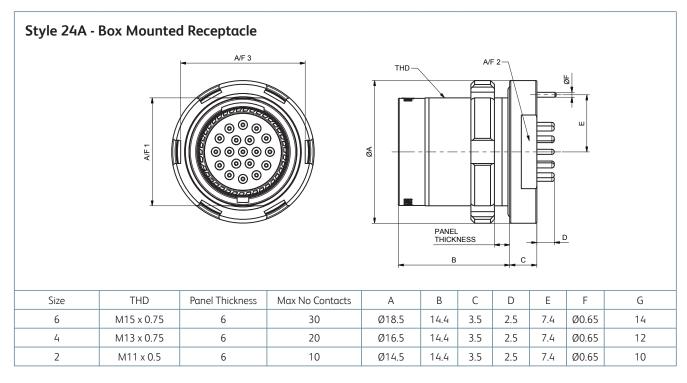
Electrical Characteristics

- Insulation resistance: 30,000Mohms
- Dielectric withstand voltage: 750v AC
- Current rating: 3amps @ 40°C
- Contact resistance <5m ohm
- Shell to shell continuity <5m ohm





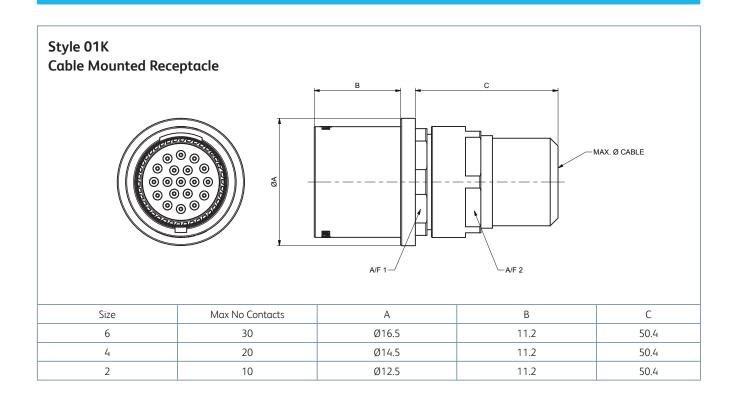


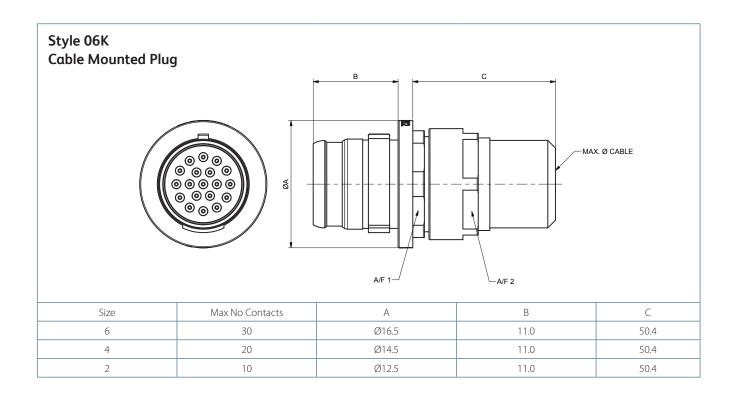


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Part Number Explanation

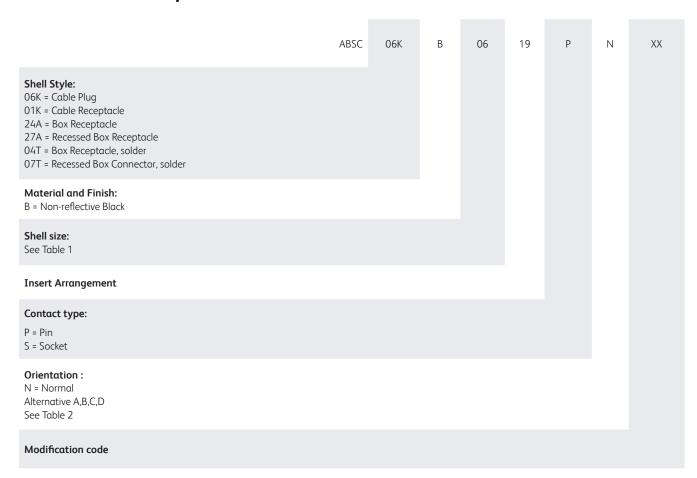
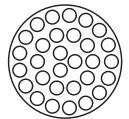


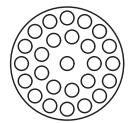




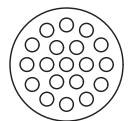
Table 1 Planforms



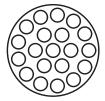
Size: 06 Planform: 30



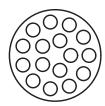
Size: 06 Planform: 26



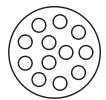
Size: 06 Planform: 19



Size: 04 Planform: 20



Size: 04 Planform: 16



Size: 04 Planform: 12



Size: 02 Planform: 10



Size: 02 Planform: 08



Size: 02 Planform: 05